
Bluetooth Module Datasheet

Model: CZW-8640-01

Version: V2.0

2015-10-12

List of Contents

1 Introduction	3
2 Key Features	3
3 Applications	4
4 Block Diagram	4
5 General specifications	4
6 Module Package Information	5
6.1 Pinout Diagram and package dimensions	5
6.2 Module Pin descriptions	6
7 Electrical Characteristics	8
7.1 Absolute Maximum Ratings	8
7.2 Recommended Operating Conditions	8
8 Recommended reflow temperature profile	9

1 Introduction

4.1 modules CZW-8640-01 which is a high performance, cost effective, low power and compact solution. The Bluetooth module provides a complete 2.4GHz Bluetooth system based on the BlueCore CSR8645 chipset which is a single chip radio and baseband IC for Bluetooth 2.4GHz systems,. This module is fully compliant to Bluetooth v4.1 for audio communications.

The module is a Bluetooth Module With EDR function.

Qperation Frequency:2402MHz~2480MHz

Number of Channel: 79

Modulation: GFSK, Pai/4-DQPSK,8-DPSK

Antenna Type: PCB Antenna

Gain: 0dBi

The module can be used for Bluetooth loudspeaker with 0dBi antenna. The host manufacturer installing this module into their product must ensure that the final compost product complies with the FCC requirements by a technical assessment or evaluation to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module. The end user manual shall include all required regulatory information/warming as show in this manual.

2 Key Features

Bluetooth Profiles

- Bluetooth v4.1 specification support
- A2DP v1.2
- AVRCP v1.4
- HFP v1.6
- HSP v1.2
- DI v1.3

Music Enhancements

- Configurable 5-band EQ for music playback (rock,pop, classical, jazz, dance etc)
- SBC, MP3, AAC and Faststream decoder
- Volume Boost
- Stereo Widening (S3D)

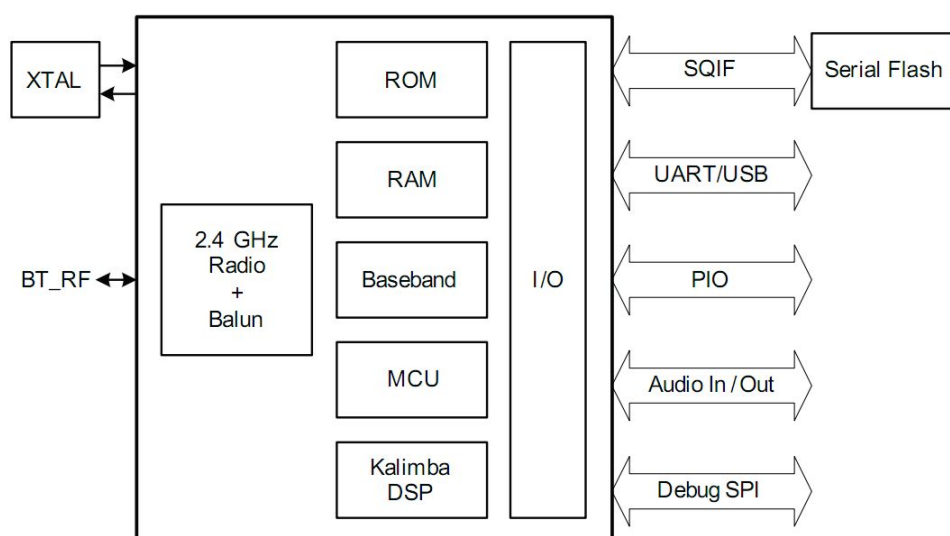
Additional Functionality

- Support for multi-language programmable audio prompts
- CSR's proximity pairing and CSR's proximity connection
- Multipoint support for A2DP connection to 2 A2DP sources for music playback
- Talk-time extension
- Slim module with 28.5mm x 13mm x 2.0mm

3 Applications

- Stereo Headsets
- Wired Stereo headsets and headphones
- Portable Bluetooth Stereo speakers

4 Block Diagram

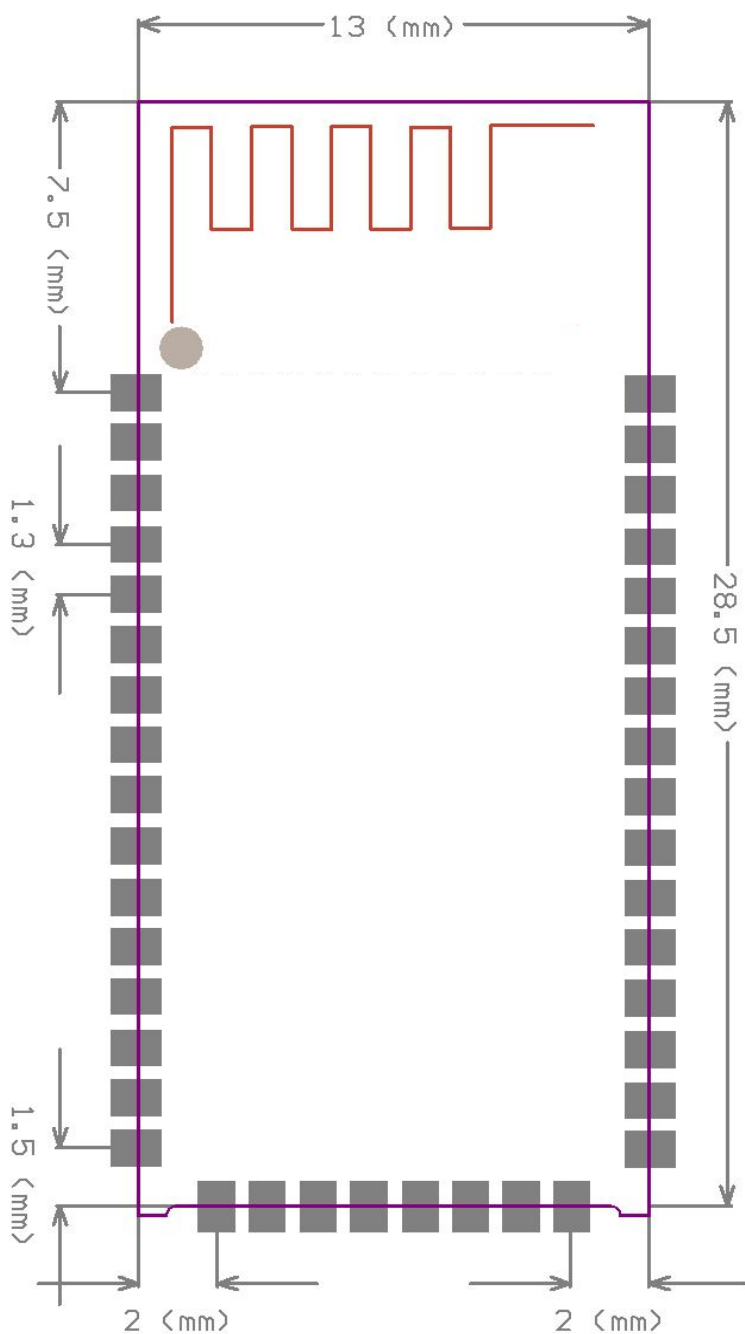


5 General specifications

Model Name	CZW-8640-01
Product Description	Bluetooth 4.0 Class2 Module
Bluetooth Standard	Bluetooth 4.0
Chipset	CSR8640
Dimension	28.5mm x 13mm x 2.0mm
Operating Conditions	
Voltage	2.8~4.2V
Temperature	-10~+70°C
Storage Temperature	-40~+85°C
Electrical Specifications	
Frequency Range	2402~2480MHz
Maximum RF Transmit Power	2.096dBm
$\pi/4$ DQPSK Receive Sensitivity	-91dBm
8DPSK Receive Sensitivity	-81dBm

6 Module Package Information

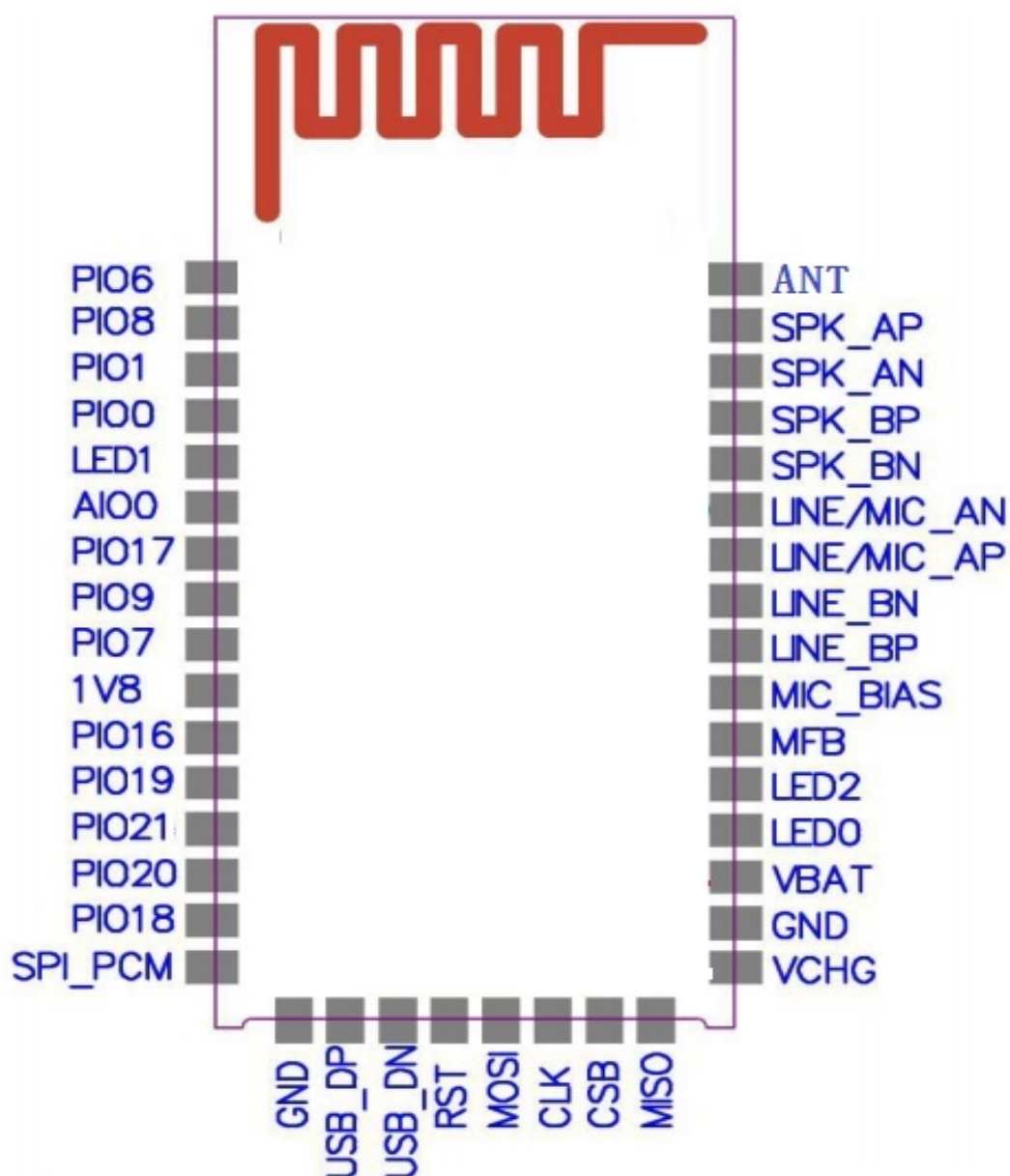
6.1 Pinout Diagram and package dimensions



Unit: MM

Recommended PCB layout footprint

6.2 Module Pin descriptions



Pin No.	Pin Name	Pin Type	Description
1	PIO6	Bidirectional with strong pull-down	Programmable input/output line 6
2	PIO8	Bidirectional with strong pull-up	Programmable input/output line 8
3	PIO1	Bidirectional with strong pull-up	Programmable input/output line 1
4	PIO0	Bidirectional with strong pull-up	Programmable input/output line 0
5	LED1	Bidirectional	LED driver
6	AIO0	Bidirectional	Analogue programmable input/output line
7	PIO17	Bidirectional with strong pull-down	Programmable input/output line 17
8	PIO9	Bidirectional with strong pull-down	Programmable input/output line 9

9	PIO7	Bidirectional with strong pull-down	Programmable input/output line 7
10	1V8	1.8V output	1.8V output for keys
11	PIO16	Bidirectional with strong pull-up	Programmable input/output line 16
12	PIO19	Bidirectional with strong pull-up	Programmable input/output line 19
13	PIO20	Bidirectional with strong pull-up	Programmable input/output line 20
14	PIO21	Bidirectional with weak pull-down	Programmable input/output line 21
15	PIO18	Bidirectional with weak pull-down	Programmable input/output line 18
16	SPI_PCM#	Input with weak pull-down	SPI/PCM select input: 0 = PCM/PIO interface 1 = SPI
17	GND	VSS	Ground
18	USB_P	Bidirectional	USB data plus
19	USB_N	Bidirectional	USB data minus
20	RSTn	Input with strong pull-up	Reset if low. Pull low for minimum 5ms to cause a reset.
21	SPI_MOSI	Bidirectional with weak pull-down	Programmable input / output line 2 Alternative function: SPI_MOSI: Debug SPI data input
22	SPI_CLK	Bidirectional with weak pull-down	Programmable input / output line 5 Alternative function: SPI_CLK: Debug SPI clock
23	SPI_CSB	Bidirectional with weak pull-down	Programmable input / output line 4 Alternative function: SPI_CS#: chip select for Debug
24	SPI_MISO	Bidirectional with weak pull-down	Programmable input / output line 3 Alternative function: SPI_MISO: Debug SPI data output
25	VCHG	Charger voltage input	Internal charger input for charging
26	GND	VSS	Ground
27	VBAT	Battery positive terminal	Power supply input for 2.8~4.2V
28	LED0	Bidirectional	LED driver
29	LED2	Bidirectional	LED driver
30	VREG_EN	Power on/off key input	Power on/off input key indication

31	MIC_BIAS	Analog	Microphone bias output
32	LINE_BN	Analog input	Line input negative, channel B
33	LINE_BP	Analog input	Line input positive, channel B
34	LINE/MIC_AP	Analog input	Line or microphone input positive, channel
35	LINE/MIC_AN	Analog input	Line or microphone input negative, channe
36	SPK_BN	Analog output	Speaker output negative right
37	SPK_BP	Analog output	Speaker output positive right
38	SPK_AN	Analog output	Speaker output negative left
39	SPK_AP	Analog output	Speaker output positive left
40	ANT/NC	External.antenn.	ANT/NC

7 Electrical Characteristics

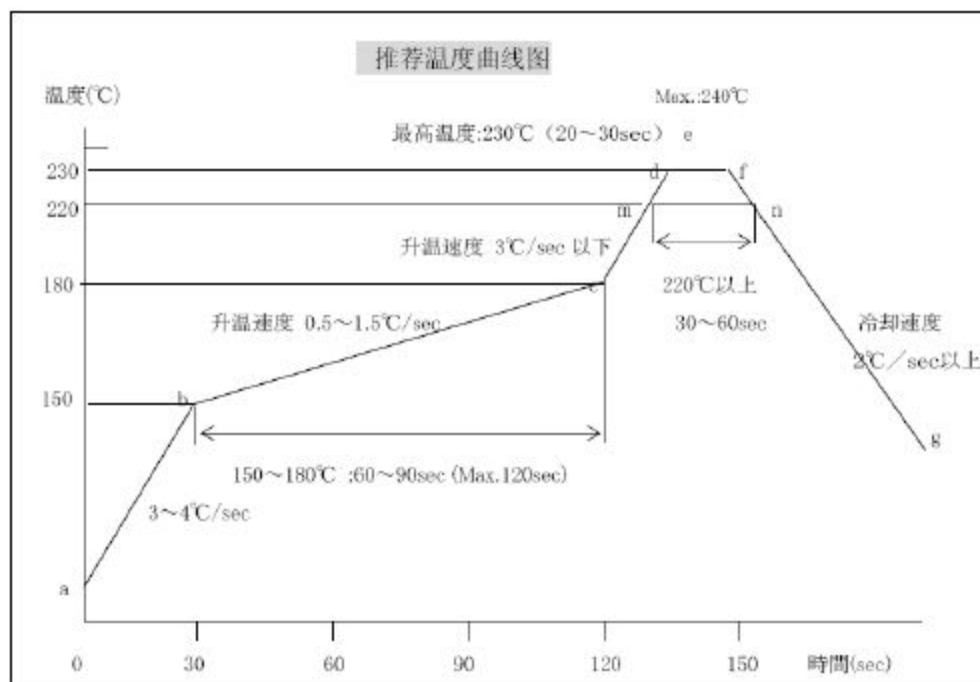
7.1 Absolute Maximum Ratings

Rating	Minimum	Maximum
Storage temperature	-40°C	+85°C

7.2 Recommended Operating Conditions

Operating Condition	Minimum	Maximum
Operating temperature range	-10°C	+70°C
Supply voltage: VBAT	+2.8V	+4.2V

8 Recommended reflow temperature profile





CAUTION
This bag contains
MOISTURE-SENSITIVE DEVICES

LEVEL

3

If Blank, see adjacent
bar code label

1. Calculated shelf life in sealed bag: 12 months at < 40 °C and < 90% relative humidity (RH)
2. Peak package body temperature: _____ 260 _____ °C
If Blank, see adjacent bar code label
3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must
 - a) Mounted within: _____ 168 _____ hours of factory
If Blank, see adjacent bar code label

conditions ≤ 30 °C / 60 %

 - b) stored at < 10%RH
4. Devices require bake, before mounting, if :
 - a) Humidity Indicator Card is > 10 % when read at 23 ± 5 °C
 - b) 3a or 3b not met.
5. If baking is required, devices may be baked for 48 hours at 125 ± 5 °C
Note: If device containers cannot be subjected to high temperature or shorter bake times are desired,
reference IPC / JEDEC J-STQ-033 for bake procedure

Bag Seal Date: _____

If Blank, see adjacent bar code label

Note: Level and body temperature defined by IPC / JEDEC J-STQ-020

The module Must go through 125°C baking for at least 9 hours before SMT AND IR reflow process!

若拆封后未立即上线，建议让下次上线前务必以 **125°C** 烘烤 **9** 小时以上！

FCC WARNING

FCC Caution: Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate this equipment.

This device complies with Part 15 of the FCC Rules.

Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

This device and its antenna(s) must not be co-located or operating in conjunction with any other antenna or transmitter.

15.105 Information to the user.

(b) For a Class B digital device or peripheral, the instructions furnished the user shall include the following or similar statement, placed in a prominent location in the text of the manual:

Note: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules.

These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20

cm between the radiator and your body.

Radiation Exposure Statement:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment.

This transmitter must not be co-located or operating in conjunction with any other

antenna or transmitter.

The availability of some specific channels and/or operational frequency bands are country dependent and are firmware programmed at the factory to match the intended destination.

The firmware setting is not accessible by the end user.

The final end product must be labelled in a visible area with the following:

“Contains Transmitter Module 2A26F-CZW864001”

Requirement per KDB996369 D03

2.2 List of applicable FCC rules

List the FCC rules that are applicable to the modular transmitter. These are the rules that specifically establish the bands of operation, the power, spurious emissions, and operating fundamental frequencies. DO NOT list compliance to unintentional-radiator rules (Part 15 Subpart B) since that is not a condition of a module grant that is extended to a host manufacturer. See also Section 2.10 below concerning the need to notify host manufacturers that further testing is required.³

Explanation: This module meets the requirements of FCC part 15C (15.247). It specifically identified AC Power Line Conducted Emission, Radiated Spurious emissions, Band edge and RF Conducted Spurious Emissions, Conducted Peak Output Power, Bandwidth, Power Spectral Density, Antenna Requirement.

Summarize the specific operational use conditions

Describe use conditions that are applicable to the modular transmitter, including for example any limits on antennas, etc. For example, if point-to-point antennas are used that require reduction in power or compensation for cable loss, then this information must be in the instructions. If the use condition limitations extend to professional users, then instructions must state that this information also extends to the host manufacturer's instruction manual. In addition, certain information may also be needed, such as peak gain per frequency band and minimum gain, specifically for master devices in 5 GHz DFS bands.

Explanation: The EUT has one PCB antenna, the antenna can not be replaced by other authorized antennas, and only use the provide antenna.

2.3 Limited module procedures

If a modular transmitter is approved as a "limited module," then the module manufacturer is responsible for approving the host environment that the limited module is used with. The manufacturer of a limited module must describe, both in the filing and in the installation instructions, the alternative means that the limited module manufacturer uses to verify that the host meets the necessary requirements to satisfy the module limiting conditions.

A limited module manufacturer has the flexibility to define its alternative method to address the conditions that limit the initial approval, such as: shielding, minimum signaling amplitude, buffered modulation/data inputs, or power supply regulation. The alternative method could include that the limited

module manufacturer reviews detailed test data or host designs prior to giving the host manufacturer approval.

This limited module procedure is also applicable for RF exposure evaluation when it is necessary to demonstrate compliance in a specific host. The module manufacturer must state how control of the product into which the modular transmitter will be installed will be maintained such that full compliance of the product is always ensured. For additional hosts other than the specific host originally granted with a limited module, a Class II permissive change is required on the module grant to register the additional host as a specific host also approved with the module.

Explanation: The module is a limited module.

The module can be used for Bluetooth loudspeaker with 0dBi antenna. The host manufacturer installing this module into their product must ensure that the final product complies with the FCC requirements by a technical assessment or evaluation to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module. The end user manual shall include all required regulatory information/warning as shown in this manual.

2.6 RF exposure considerations

It is essential for module grantees to clearly and explicitly state the RF exposure conditions that permit a host product manufacturer to use the module. Two types of instructions are required for RF exposure information: (1) to the host product manufacturer, to define the application conditions (mobile, portable – xx cm from a person's body); and (2) additional text needed for the host product manufacturer to provide to end users in their end-product manuals. If RF exposure statements and use conditions are not provided, then the host product manufacturer is required to take responsibility of the module through a change in 2A26F-CZW864001.

Explanation: This module complies with FCC RF radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with a minimum distance of 20cm centimeters between the radiator and your body." This module is designed to comply with the FCC statement, FCC ID is: 2A26F-CZW864001.

2.7 Antennas

A list of antennas included in the application for certification must be provided in the instructions. For modular transmitters approved as limited modules, all applicable professional installer instructions must be included as part of the information to the host product manufacturer. The antenna list shall also identify the antenna types (monopole, PIFA, dipole, etc. (note that for example an "omni-directional antenna" is not considered to be a specific "antenna type"))).

For situations where the host product manufacturer is responsible for an external connector, for example with an RF pin and antenna trace design, the integration instructions shall inform the installer that unique antenna connector must be used on the Part 15 authorized transmitters used in the host product.

The module manufacturers shall provide a list of acceptable unique connectors.

Explanation: The EUT has one PCB antenna, the antenna can not be replaced by other authorized antennas, and only use the provide antenna.

2.8 Label and compliance information

Grantees are responsible for the continued compliance of their modules to the FCC rules. This

includes advising host product manufacturers that they need to provide a physical or e-label stating "Contains FCC ID" with their finished product. See Guidelines for Labeling and User Information for RF Devices – KDB Publication 784748.

Explanation: The host system using this module, should have label in a visible area indicated the following texts: "Contains FCC ID: 2A26F-CZW864001."

2.9 Information on test modes and additional testing requirements

Additional guidance for testing host products is given in KDB Publication 996369 D04 Module Integration Guide. Test modes should take into consideration different operational conditions for a stand-alone modular transmitter in a host, as well as for multiple simultaneously transmitting modules or other transmitters in a host product.

The grantee should provide information on how to configure test modes for host product evaluation for different operational conditions for a stand-alone modular transmitter in a host, versus with multiple, simultaneously transmitting modules or other transmitters in a host.

Grantees can increase the utility of their modular transmitters by providing special means, modes, or instructions that simulates or characterizes a connection by enabling a transmitter. This can greatly simplify a host manufacturer's determination that a module as installed in a host complies with FCC requirements.

Explanation: ShenZhen RF Crazy Technology Co., Ltd. can increase the utility of our modular transmitters by providing instructions that simulates or characterizes a connection by enabling a transmitter.

2.10 Additional testing, Part 15 Subpart B disclaimer

The grantee should include a statement that the modular transmitter is only FCC authorized for the specific rule parts (i.e., FCC transmitter rules) listed on the grant, and that the host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification. If the grantee markets their product

as being Part 15

Subpart B compliant (when it also contains unintentional-radiator digital circuitry), then the grantee shall provide a notice stating that the final host product still requires Part 15 Subpart B compliance testing with the modular transmitter installed.

Explanation: The module without unintentional-radiator digital circuitry, so the module does not require an evaluation by FCC Part 15 Subpart B. The host should be evaluated by the FCC Subpart B.